SHIGA7.049APC PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant : Washio et al.

Appl. No. : 10/578,398

Filed : May 4, 2006

For : THICK FILM PHOTORESIST

COMPOSITION AND METHOD OF FORMING RESIST PATTERN

Examiner : Walke, Amanda C.

Group Art Unit : 1795

AMENDMENT AND RESPONSE TO OFFICE ACTION

Mail Stop Amendment Commissioner for Patents

P.O. Box 1450 Alexandria, VA 22313-145

Dear Sir:

In response to the Office Action mailed November 14, 2008, please consider the following amendments and remarks.

Amendments to the Claims begin on page 2 of this paper.

Remarks begin on page 4 of this paper.